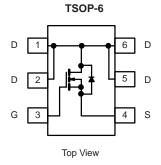


# AFN3454TS6RG-VB Datasheet N-Channel 30 V (D-S) MOSFET

| PRODUCT SUMMARY     |                                  |                                    |                       |  |  |  |
|---------------------|----------------------------------|------------------------------------|-----------------------|--|--|--|
| V <sub>DS</sub> (V) | $R_{DS(on)}\left(\Omega\right)$  | I <sub>D</sub> (A) <sup>a, e</sup> | Q <sub>g</sub> (Typ.) |  |  |  |
| 30                  | 0.023 at V <sub>GS</sub> = 10 V  | 6                                  | 4.2 nC                |  |  |  |
| 30                  | 0.027 at V <sub>GS</sub> = 4.5 V | 6                                  | 4.2110                |  |  |  |



#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- · Low On-Resistance
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC



#### **APPLICATIONS**

• DC/DC Converters, High Speed Switching

| Parameter  | Symbol                            | Limit              | Unit                |    |
|--|-----------------------------------|--------------------|---------------------|----|
| Drain-Source Voltage                               | V <sub>DS</sub>                   | 30                 | V                   |    |
| Gate-Source Voltage                                |                                   | V <sub>GS</sub>    | ± 20                | v  |
|  | T <sub>C</sub> = 25 °C            |                    | 6 <sup>e</sup>      |    |
| Continuous Proin Current /T 450 °C)                | T <sub>C</sub> = 70 °C            | ,                  | 6 <sup>e</sup>      |    |
| Continuous Drain Current (T <sub>J</sub> = 150 °C) | T <sub>A</sub> = 25 °C            | - I <sub>D</sub>   | 5.5 <sup>b, c</sup> |    |
|  | T <sub>A</sub> = 70 °C            |                    | 4.4 <sup>b, c</sup> | А  |
| Pulsed Drain Current (t = 300 μs)                  |                                   | I <sub>DM</sub> 25 |                     |    |
| Continuous Course Dunin Diede Current              | T <sub>C</sub> = 25 °C            |                    | 2.1                 |    |
| Continuous Source-Drain Diode Current              | T <sub>A</sub> = 25 °C            | ls —               | 1.1 <sup>b, c</sup> |    |
|  | T <sub>C</sub> = 25 °C            |                    | 2.5                 |    |
| Manine de Deves Dissination                        | T <sub>C</sub> = 70 °C            |                    | 1.6                 | w  |
| Maximum Power Dissipation                          | T <sub>A</sub> = 25 °C            | P <sub>D</sub>     | 1.3 <sup>b, c</sup> | VV |
|  | T <sub>A</sub> = 70 °C            |                    | 0.8 <sup>b, c</sup> |    |
| Operating Junction and Storage Temperature         | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 150        | 90                  |    |
| Soldering Recommendations (Peak Tempera            |                                   | 260                | °C                  |    |

| THERMAL RESISTANCE RATINGS                  |              |                   |         |      |       |  |  |
|---|--------------|-------------------|---------|------|-------|--|--|
| Parameter                                   | Symbol       | Typical           | Maximum | Unit |       |  |  |
| Maximum Junction-to-Ambient <sup>b, d</sup> | t ≤ 5 s      | R <sub>thJA</sub> | 75      | 100  | °C/W  |  |  |
| Maximum Junction-to-Foot (Drain)            | Steady State | R <sub>thJF</sub> | 40      | 50   | C/ VV |  |  |

#### Notes:

- a. Based on  $T_C = 25$  °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c t = 5 s
- d. Maximum under steady state conditions is 166 °C/W.
- e. Package limited.

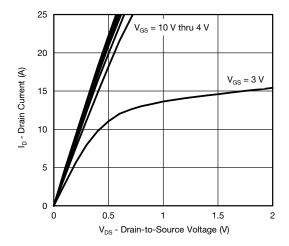


| Parameter                                     | Symbol                  | Test Conditions   | Min. | Тур.  | Max.  | Unit   |
|---|-------------------------|---|------|-------|-------|--------|
| Static  |                         |   |      |       |       | •      |
| Drain-Source Breakdown Voltage                | V <sub>DS</sub>         | $V_{GS} = 0 \text{ V, } I_D = 250  \mu\text{A}$   |      |       |       | V      |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_{J}$   | $I_D = 250 \mu\text{A}$   |      | 30    |       | m\//°C |
| V <sub>GS(th)</sub> Temperature Coefficient   | $\Delta V_{GS(th)}/T_J$ | i <sub>D</sub> = 250 μA   |      | - 4.8 |       | mV/°C  |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}$ , $I_D = 250 \mu A$   | 0.5  |       | 1.5   | V      |
| Gate-Source Leakage                           | I <sub>GSS</sub>        | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$   |      |       | ± 100 | nA     |
| Zana Cata Valtana Duain Comment               | I <sub>DSS</sub>        | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V   |      |       | 1     | μΑ     |
| Zero Gate Voltage Drain Current               |                         | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$                  |      |       | 10    |        |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>      | $V_{DS} \le 5 \text{ V}, V_{GS} = 10 \text{ V}$   | 20   |       |       | Α      |
| D : 0   |                         | $V_{GS} = 10 \text{ V}, I_D = 5.5 \text{ A}$  |      | 0.023 |       |        |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>     | $V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$   |      | 0.027 |       | Ω      |
| Forward Transconductance <sup>a</sup>         |                         |   |      | 24    |       | S      |
| Dynamic <sup>b</sup>                          |                         |   |      | "     |       |        |
| Input Capacitance                             | C <sub>iss</sub>        |   |      | 424   |       |        |
| Output Capacitance                            | C <sub>oss</sub>        | $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$                            |      | 100   |       | pF     |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>        |   |      | 42    |       |        |
| T. 10 . 01                                    | Q <sub>g</sub>          | $V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5.5 \text{ A}$                       |      | 8.2   | 13    | nC     |
| Total Gate Charge                             |                         |   |      | 4.2   | 7     |        |
| Gate-Source Charge                            | $Q_{gs}$                | $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5.5 \text{ A}$                      |      | 1.4   |       |        |
| Gate-Drain Charge                             | $Q_{gd}$                |   |      | 1.4   |       |        |
| Gate Resistance                               | $R_g$                   | f = 1 MHz   | 2.5  | 12.6  | 25.2  | Ω      |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |   |      | 6     | 12    | ns     |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD}$ = 15 V, $R_L$ = 3.4 $\Omega$   |      | 20    | 30    |        |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $I_D \approx 4.4 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$                        |      | 14    | 21    |        |
| Fall Time                                     | t <sub>f</sub>          |   |      | 10    | 20    |        |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |   |      | 3     | 6     |        |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD}$ = 15 V, $R_L$ = 3.4 $\Omega$   |      | 11    | 20    |        |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $I_D \cong 4.4 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$                           |      | 20    | 30    |        |
| Fall Time                                     | t <sub>f</sub>          |   |      | 7     | 14    |        |
| <b>Drain-Source Body Diode Characteristic</b> | cs                      |   |      | L     | L     | ı      |
| Continuous Source-Drain Diode Current         | I <sub>S</sub>          | T <sub>C</sub> = 25 °C  |      |       | 2.1   | ۸      |
| Pulse Diode Forward Current                   | I <sub>SM</sub>         |   |      |       | 25    | A      |
| Body Diode Voltage                            | $V_{SD}$                | $I_S = 4.4 \text{ A}, V_{GS} = 0 \text{ V}$   |      | 0.82  | 1.2   | V      |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>         |   |      | 13    | 20    | ns     |
| Body Diode Reverse Recovery Charge            | Q <sub>rr</sub>         | L = 4.4.6 dl/dt = 100.6/m T = 25.90   |      | 6     | 12    | nC     |
| Reverse Recovery Fall Time                    | t <sub>a</sub>          | $I_F = 4.4 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ |      | 8     |       |        |
| Reverse Recovery Rise Time                    | t <sub>b</sub>          |   |      | 5     |       | ns     |

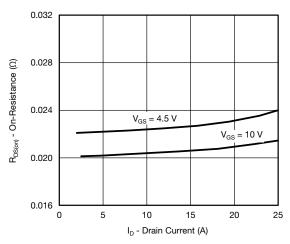
- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

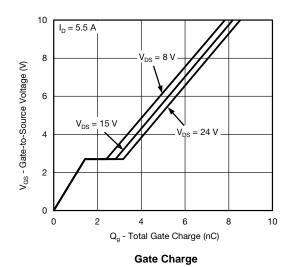




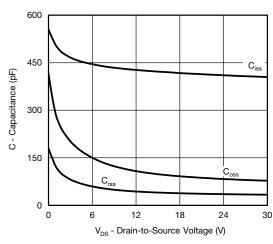
#### **Output Characteristics**



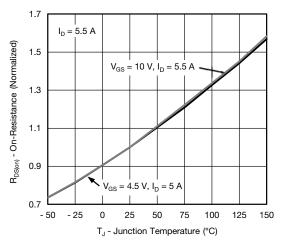
On-Resistance vs. Drain Current and Gate Voltage



**Transfer Characteristics** 

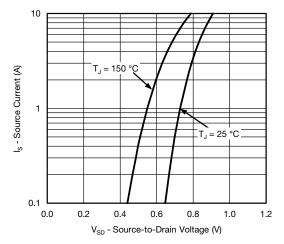


Capacitance

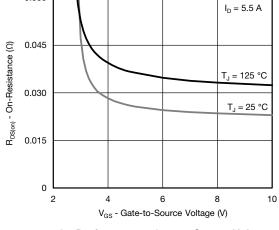


On-Resistance vs. Junction Temperature



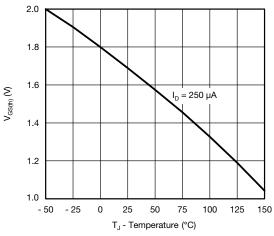


#### Source-Drain Diode Forward Voltage

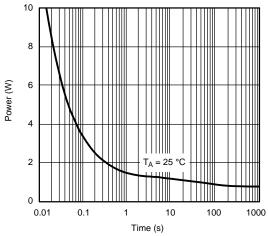


0.060

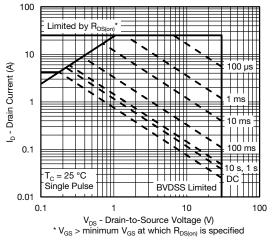
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 

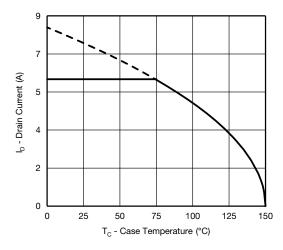


Single Pulse Power (Junction-to-Ambient)

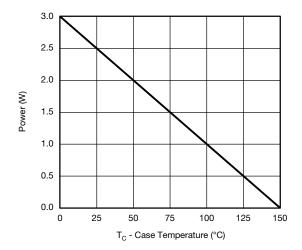


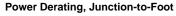
Safe Operating Area, Junction-to-Ambient

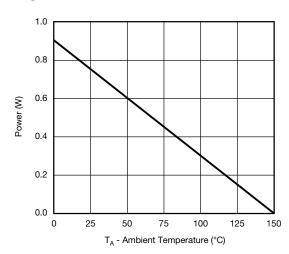




#### **Current Derating\***



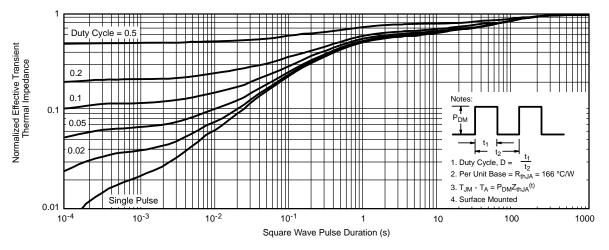




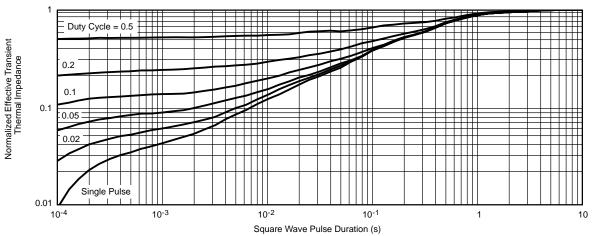
Power Derating, Junction-to-Ambient

<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max.)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient

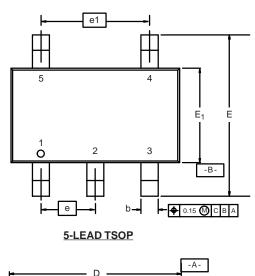


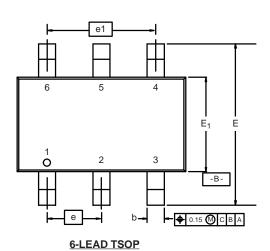
Normalized Thermal Transient Impedance, Junction-to-Foot

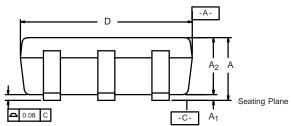


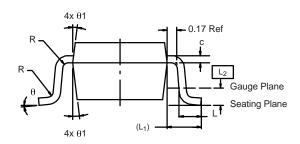
TSOP: 5/6-LEAD

**JEDEC Part Number: MO-193C** 





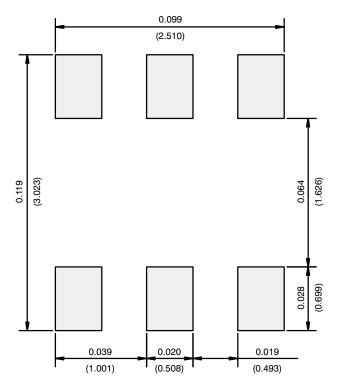




|   | MILLIMETERS |      |      | INCHES     |       |       |  |
|---|-------------|------|------|------------|-------|-------|--|
| Dim   | Min         | Nom  | Max  | Min        | Nom   | Max   |  |
| Α   | 0.91        | -    | 1.10 | 0.036      | -     | 0.043 |  |
| A <sub>1</sub>                              | 0.01        | -    | 0.10 | 0.0004     | -     | 0.004 |  |
| A <sub>2</sub>                              | 0.90        | -    | 1.00 | 0.035      | 0.038 | 0.039 |  |
| b   | 0.30        | 0.32 | 0.45 | 0.012      | 0.013 | 0.018 |  |
| С   | 0.10        | 0.15 | 0.20 | 0.004      | 0.006 | 0.008 |  |
| D   | 2.95        | 3.05 | 3.10 | 0.116      | 0.120 | 0.122 |  |
| Е   | 2.70        | 2.85 | 2.98 | 0.106      | 0.112 | 0.117 |  |
| E <sub>1</sub>                              | 1.55        | 1.65 | 1.70 | 0.061      | 0.065 | 0.067 |  |
| е   | 0.95 BSC    |      |      | 0.0374 BSC |       |       |  |
| e <sub>1</sub>                              | 1.80        | 1.90 | 2.00 | 0.071      | 0.075 | 0.079 |  |
| L   | 0.32        | -    | 0.50 | 0.012      | -     | 0.020 |  |
| L <sub>1</sub>                              | 0.60 Ref    |      |      | 0.024 Ref  |       |       |  |
| L <sub>2</sub>                              | 0.25 BSC    |      |      | 0.010 BSC  |       |       |  |
| R   | 0.10        | -    | -    | 0.004      | -     | -     |  |
| θ   | 0°          | 4°   | 8°   | 0°         | 4°    | 8°    |  |
| θ1  | 7° Nom      |      |      | 7° Nom     |       |       |  |
| ECN: C-06593-Rev. I, 18-Dec-06<br>DWG: 5540 |             |      |      |            |       |       |  |



#### **RECOMMENDED MINIMUM PADS FOR TSOP-6**



Recommended Minimum Pads Dimensions in Inches/(mm)



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